Editor-in-Chief: Michael Wald

Volume 20 Number 6

### Part I

## Special Issue on Spreadsheet Applications in

## **Engineering Education**

## **Guest Editors Chung-yau Lam and Karim Kabalan**

## Part II

# Contributions in Engineering Education Research, Electronic Engineering, Industrial Engineering and Chemical Engineering

INDEXED/ABSTRACTED IN: INSPEC DATABASE Science Citation Index/Current Contents

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